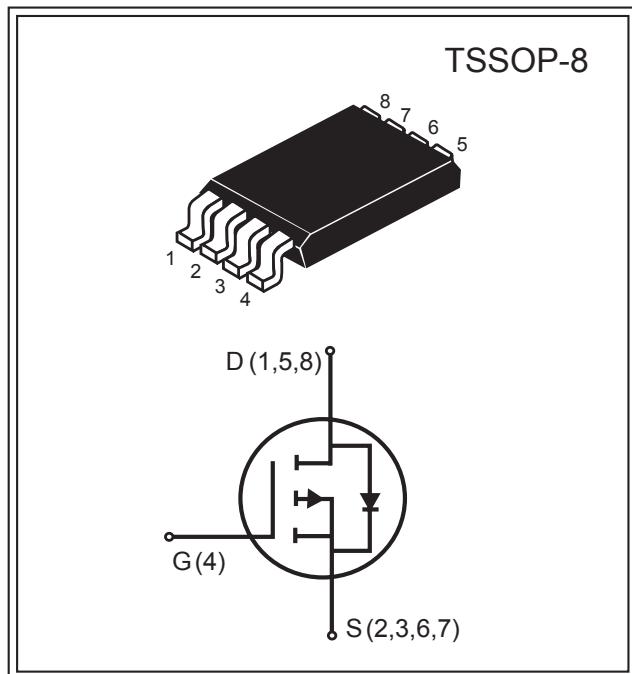


Product Summary		
V <sub>DS</sub> (V)	I <sub>D</sub> (A)	R <sub>DS(ON)</sub> (mΩ) Max
- 30V	- 5A	45 @ V <sub>GS</sub> = - 10V
		75 @ V <sub>GS</sub> = - 5V
		90 @ V <sub>GS</sub> = - 4.5V



## FEATURES

- ◆ Super high density cell design for low R<sub>DS(ON)</sub>.
- ◆ Rugged and reliable.
- ◆ TSSOP-8 package.
- ◆ Pb free.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	- 30	V
Gate-Source Voltage	V <sub>GS</sub>	±25	V
Drain Current-Continuous @ T <sub>J</sub> = 125°C -Pulsed <sup>b</sup>	I <sub>D</sub>	- 5	A
	I <sub>DM</sub>	- 20	A
Drain-Source Diode Forward Current <sup>a</sup>	I <sub>S</sub>	- 1.5	A
Maximum Power Dissipation <sup>a</sup>	P <sub>D</sub>	1.5	W
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	- 55 to 150	°C

## THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient <sup>a</sup>	R <sub>θ JA</sub>	82	°C/W
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**P-Channel Electrical Characteristics ( $T_A = 25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ <sup>c</sup>	Max	Unit
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}= - 250 \mu\text{A}$	-30			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}= - 24\text{V}, V_{\text{GS}}=0\text{V}$			- 1	$\mu\text{A}$
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{GS}}= \pm 25\text{V}, V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}= - 250 \mu\text{A}$	- 1	- 1.8	- 2.5	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}= - 10\text{V}, I_{\text{D}}= - 5.0\text{A}$		38	45	$\text{m}\Omega$
		$V_{\text{GS}}= - 5\text{V}, I_{\text{D}}= - 4.0\text{A}$		65	75	
		$V_{\text{GS}}= - 4.5\text{V}, I_{\text{D}}= - 3.0\text{A}$		75	90	
On-State Drain Current	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}}= - 5\text{V}, V_{\text{GS}}= - 10\text{V}$	- 20			A
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}}= - 15\text{V}, I_{\text{D}}= - 5\text{A}$		10		S
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}= - 15\text{V}$ $V_{\text{GS}}=0\text{V}$ $f=1.0\text{MHz}$		700	800	$\text{pF}$
Output Capacitance	$C_{\text{oss}}$			130		
Reverse Transfer Capacitance	$C_{\text{RSS}}$			90		
Turn-On Delay Time	$t_{\text{D}(\text{ON})}$	$V_{\text{DD}}= - 15\text{V},$ $I_{\text{D}}= - 1\text{A},$ $V_{\text{GEN}}= - 10\text{V},$ $R_{\text{GEN}}=6\Omega,$		10		$\text{ns}$
Rise Time	$t_{\text{r}}$			8		
Turn-Off Delay Time	$t_{\text{D}(\text{OFF})}$			40		
Fall Time	$t_{\text{f}}$			30		
Total Gate Charge	$Q_{\text{g}}$	$V_{\text{DS}}= - 15\text{V}, I_{\text{D}}= - 4\text{A}, V_{\text{GS}}= - 10\text{V}$		16	20	$\text{nC}$
		$V_{\text{DS}}= - 15\text{V}, I_{\text{D}}= - 4\text{A}, V_{\text{GS}}= - 4.5\text{V}$		9		
Gate-Source Charge	$Q_{\text{gs}}$	$V_{\text{DS}}= - 15\text{V},$ $I_{\text{D}}= - 6\text{A},$ $V_{\text{GS}}= - 10\text{V}$		3		
Gate-Drain Charge	$Q_{\text{gd}}$			3.5		
Diode Forward Voltage	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}= - 1.0\text{A}$		- 0.75	- 1.2	V

**Notes :**

- a. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
- b. Pulse Test : Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
- c. Guaranteed by design, not subject to production testing.



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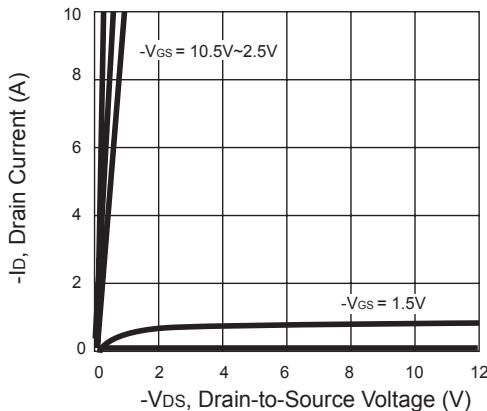


Figure 1. Output Characteristics

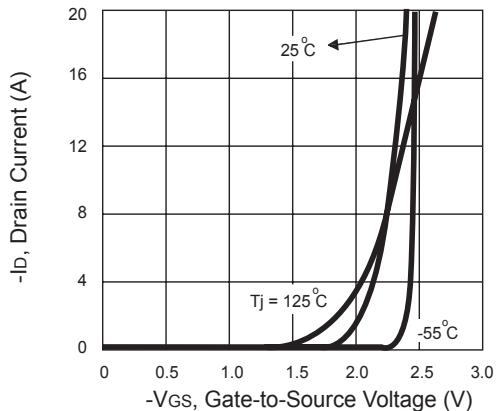


Figure 2. Transfer Characteristics

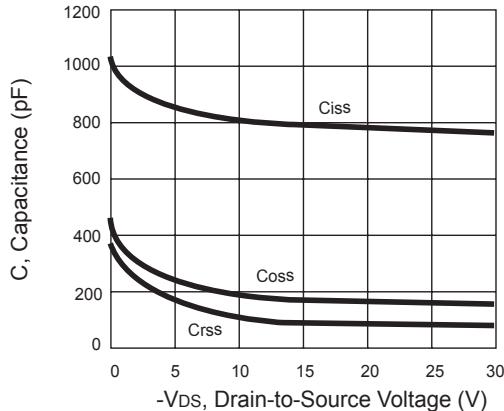


Figure 3. Capacitance

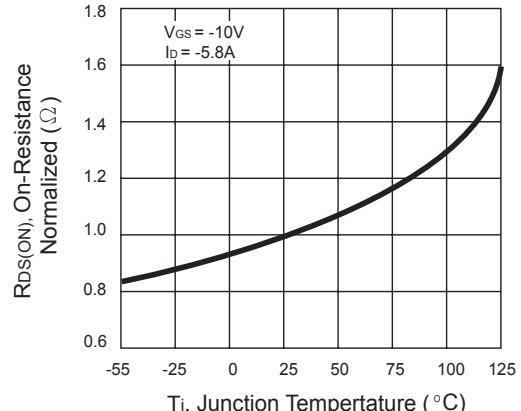


Figure 4. On-Resistance Variation with Temperature

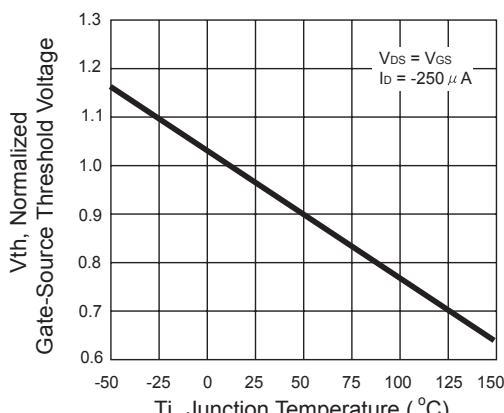


Figure 5. Gate Threshold Variation with Temperature

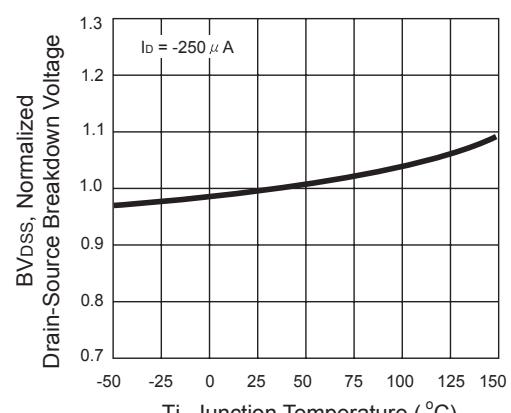


Figure 6. Breakdown Voltage Variation with Temperature

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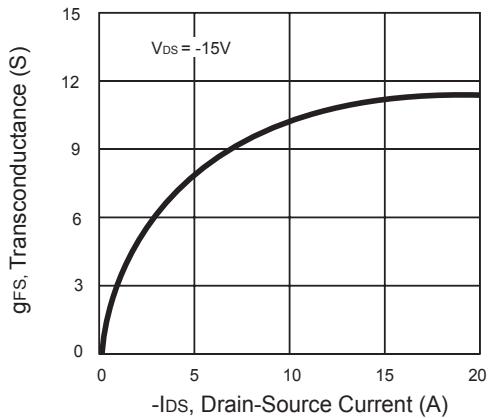


Figure 7. Transconductance Variation with Drain Current

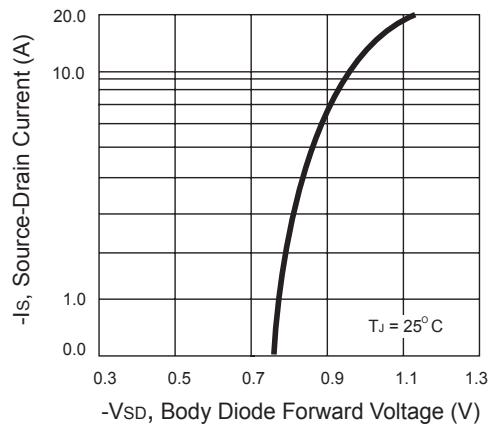


Figure 8. Body Diode Forward Voltage Variation with Source Current

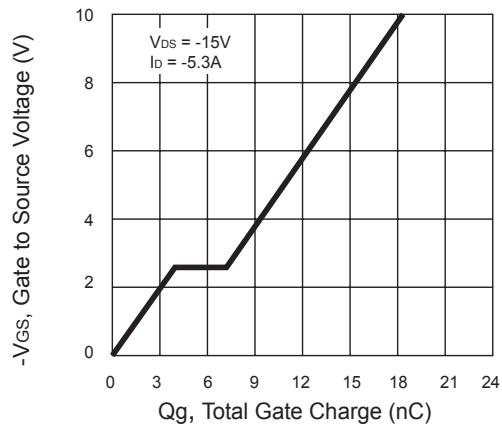


Figure 9. Gate Charge

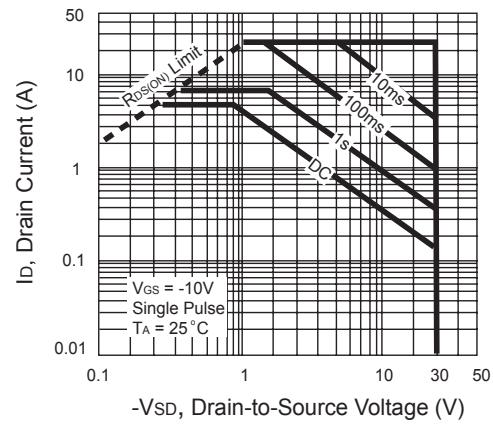


Figure 10. Maximum Safe Operating Area



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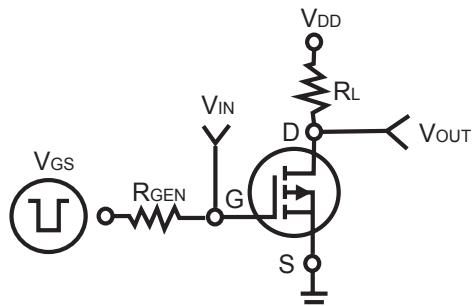


Figure 11. Switching Test Circuit

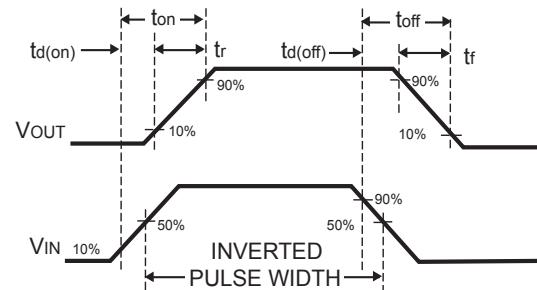


Figure 12. Switching Waveforms

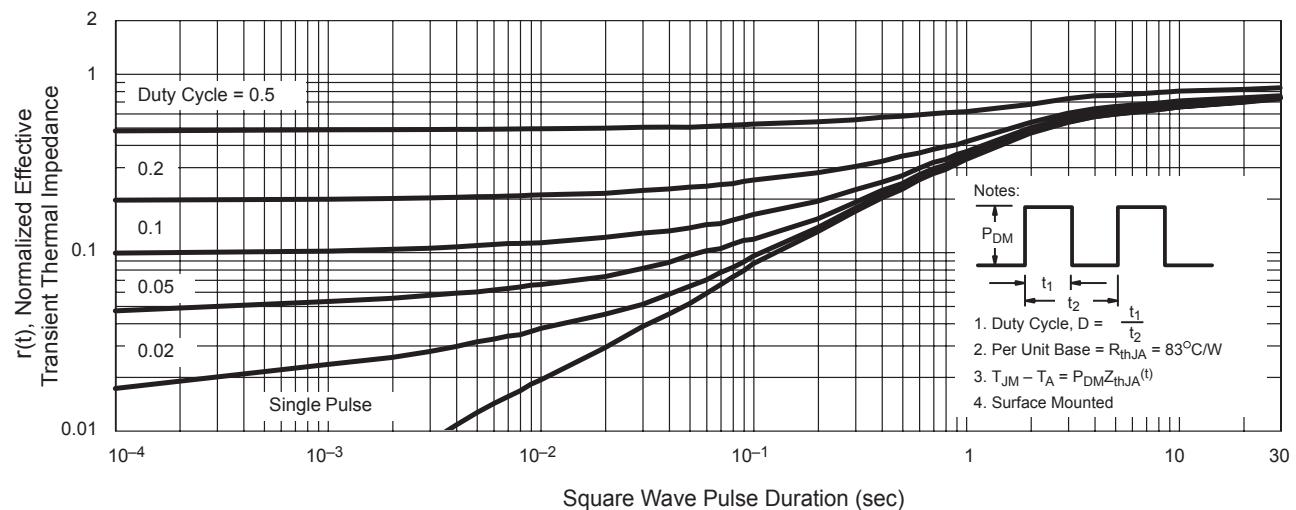


Figure 13. Normalized Thermal Transient Impedance Curve